

Badge Control Module

Features

- · Quality engineering
- Dedicated SAO power control pin
 - SAO 1.69bis compatible
- 3.3V pin voltage
 - Do not use 5V logic on pins
- CPU
 - 240MHz 32-bit MCU
- Memory
 - 520kB SRAM
 - 4MB QSPI flash
- · Wireless
 - 802.11 b/g/n
- · Serial communication interfaces
 - 2x UART
 - I²C
 - Morse code
- Analog to digital converter
 - 12-bit 4 channels
- · Digital to analog converter
 - 8-bit 2 channels
- HHV{badge1_Thx_4_RTFM}
- Full-color display
 - 1.14 inch
 - 135x240 resolution
- Drives all the LEDs
- · Encryption module
 - XOR encryption
- IO and Packaging
 - 7 Programmable IO
 - 12 pin package

Description

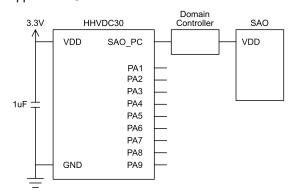
The HHVDC30 is a cutting-edge design, developed specifically for controlling and driving electronic conference badges. It is capable of driving all the LEDs, to ensure badges are as blinding as ever.

A game-changing feature added the HHVDC30 is Secondary Add-On (SAO) power control pin. Specifically designed for the SAO 1.69bis protocol, the SAO power control feature helps ensure conference badges will only support select SAOs; reducing the market opportunities for counterfeits and "indie" SAOs, and increasing conference SWAG sales.

Applications

- · Conference badges
- Security badges
- Local meetup event badges
- Family Cookout badges
- BADGES!

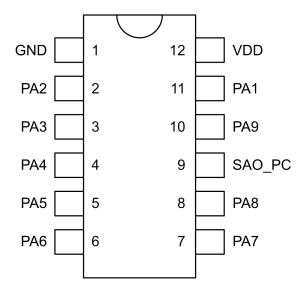
Application Circuit



1

Badge Control Module

Pin Configuration and Functions



	PIN		5	400	D.4.0	100	LIADT	
No.	Name	I/O	Description	ADC	DAC	I2C	UART	
11	PA1	Ю	General purpose IO			I2C0 SDA		
2	PA2	Ю	General purpose IO					
3	PA3	I	Dedicated input	ADC0_CH0			UART0 RX	
4	PA4	0	Dedicated output	ADC0_CH1			UART0 TX	
5	PA5	Ю	General purpose IO	ADC0_CH2				
6	PA6	Ю	General purpose IO					
7	PA7	Ю	General purpose IO		DAC0		UART1 RX	
8	PA8	Ю	General purpose IO	ADC0_CH3	DAC1		UART1 TX	
10	PA9	Ю	General purpose IO			I2C0 SCL		
9	SAO_PC	Ο	SAO power control pin					
1	GND	—	Ground					
12	VDD		Input power supply (2.3V~3.3V)					

Recommended Voltages

Badge Control Module

		Min	Typical	Max	Unit
VIN	Input voltage	2.3	3.3	3.6	V
Vsao	SAO output voltage	-	3.3	-	٧

DC Characteristics

		Min	Typical	Max	Unit
Cin	Pin capacitance	-	2	-	рF
VIH	High-level input voltage	0.75 × V _{DD}	3.3	V _{DD} + 0.3	V
VIL	Low-level input voltage	-0.3	VIN	0.25 × V _{DD}	V
Іін	High-level input current	-	-	50	nA
l⊩	Low-level input current	-	-	50	nA
Vон	High-level output voltage	$0.8 \times V_{DD}$	-	-	V
Vol	Low-level output voltage	-	-	0.1 × V _{DD}	V
Іон	High-level source current	-	20	-	mA
loL	Low-level sink current	-	28	-	mA
Vspch	SAO power control high output voltage	$0.8 \times V_{DD}$	-	-	V
Vspcl	SAO power control low output voltage	-	-	0.1 × V _{DD}	V
Rpu	Resistance of internal pull-up resistor		45		kΩ
Rpd	Resistance of internal pull-down resistor		45		kΩ

SAO Power Control

An industry changing feature of this module is the Secondary Add-On (SAO) Power Control pin. This functionality allows a badge designer to lock down use of the SAO port to select SAOs. It is up to the badge designer to select a method of verification or DRM, but communication methods specified in the SAO 1.69bis protocol are supported by the HHVDC30.

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Badge Control Module

Packaging Information

Device Part Number	Status	Package Type	Pins	Op Temp (° C)	Device Marking
HHVDC30	PRE	DIP	12	-10 to 125	HHVDC30

Ordering Information

This module is currently in pre-production. Please reach out to an HHV Volunteer if you would like order samples.

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Badge Control Module

Revision History

Date	Version	Release notes
2022.08	V1.0	Initial release

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